

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc2855hde#trpbf

(Engineering Calculation)

DFN 4mm X 3mm Exp. Pad

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TOTAL MASS (g) : 0.031489

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001781	1000000	56559.7304688		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.012783	975000	405953.40625		
		Iron (Fe)	7439-89-6	0.000315	24000	10003.5458984		
		Phosphorus (P)	7723-14-0	0.000004	300	127.029151917		
		Zinc (Zn)	7440-66-6	0.000009	700	285.815582275		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.013111	1000000	416369.78125		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000607	1000000	19271.421875		
		External Plating Total:				0.000607	1000000	19271.421875
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000295	1000000	9368.40039062		
		Internal Plating Total:				0.000295	1000000	9368.40039062
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000845	750000	26834.90625		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000282	250000	8955.5546875		
Die Attach Total:				0.001127	1000000	35790.4609375		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001888	130000	59957.7617188		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.012487	860000	396553.25		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000145	10000	4604.80664062		
		Encapsulation Total:				0.014520	1000000	461115.8125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000048	1000000	1524.34973145		
					TOTAL MASS (g) :	0.031489		